

- 1 Introduction p. 1
- 1.1 Abrasive Processes p. 1
- 1.1.1 Grinding p. 2
- 1.1.2 Honing p. 3
- 1.1.3 Lapping p. 3
- 1.1.4 Polishing p. 3
- 1.2 Abrasives p. 4
- 1.3 Tribological Principles p. 5
- 1.3.1 Two-body Abrasion p. 6
- 1.3.2 Three-body Abrasion p. 6
- 1.4 A Typical Grinding Process p. 7
- 1.5 A Tribological System p. 10
- References p. 11
- 2 Tribosystems of Abrasive Machining Processes p. 13
- 2.1 Introduction p. 13
- 2.2 Structure of Tribomechanical Processing p. 17
- 2.2.1 The Interconnecting Elements in the Tribosystem Structure p. 17
- 2.2.2 The Optimum Properties of the Tribosystem p. 17
- 2.2.3 Interrelationships Between System Elements p. 19
- 2.2.4 The Total Structural System p. 23
- 2.3 The Three Tribosystems in Abrasive Machining p. 25
- 2.3.1 Bonded Abrasive Processes p. 25
- 2.3.2 Loose Abrasive Processes p. 28
- 2.3.3 Dressing Processes p. 29
- 2.3.4 Basic Parameters of the Tribosystem Structure p. 30
- 2.4 Modeling Tribosystems of Abrasive Processes p. 30
- 2.4.1 The Influence of the Workmaterials in Modeling p. 33
- 2.4.2 The Influence of the Shape and Size of the Contact Surface p. 35
- 2.4.3 The Influence and Measurement of Cutting Forces p. 35
- 2.5 Conclusions p. 38
- References p. 38
- 3 Kinematic Models of Abrasive Contacts p. 41
- 3.1 Introduction p. 41
- 3.1.1 Machine Control Variables p. 43
- 3.1.2 Workpiece Material Removal p. 43
- 3.1.3 Volume Tool Wear p. 45
- 3.1.4 Grinding Ratio p. 45
- 3.2 Basic Analysis of Surface Grinding p. 46
- 3.2.1 Micromilling Analogy p. 46
- 3.2.2 Geometric Contact Length p. 48
- 3.2.3 Kinematic Contact Length p. 50
- 3.2.4 Grain Penetration Depth or Uncut Chip Thickness p. 51
- 3.2.5 Uncut Chip Aspect Ratio p. 54
- 3.3 Cylindrical Grinding Contacts p. 54
- 3.3.1 External Cylindrical Plunge Grinding p. 55
- 3.3.2 Removal Rate in Cylindrical Plunge Grinding p. 55

- 3.3.3 Effect of G-ratio on Removal Rate p. 56
- 3.3.4 Effect of G-ratio on Depth of Cut p. 57
- 3.3.5 Geometric Contact Length in Cylindrical Grinding p. 57
- 3.3.6 Uncut Chip Thickness in Cylindrical Grinding p. 59
- 3.3.7 Basic Parameters for Internal Cylindrical Grinding p. 60
- 3.3.8 Uncut Chip Aspect Ratio in Cylindrical Grinding p. 62
- 3.3.9 Angle Grinding of Cylindrical Parts p. 62
- 3.3.10 Comparisons of Surface, Internal, and External Grinding p. 64
- 3.3.11 Centerless Grinding p. 64
- 3.4 Implications of the Stochastic Nature of Grinding p. 67
- 3.4.1 Mean Uncut Chip Thickness p. 67
- 3.4.2 Cutting Edge Density p. 68
- 3.4.3 Mean Uncut Chip Cross-sectional Area p. 70
- 3.4.4 Equivalent Chip Thickness p. 71
- 3.4.5 Grain Spacing p. 72
- 3.4.6 Effect of Grain Shape p. 73
- 3.4.7 Effect of Increasing Grain Density p. 76
- 3.4.8 Effects on Grain Wear p. 78
- 3.4.9 Irregular Grain Spacing p. 79
- 3.4.10 Irregular Grain Depth p. 81
- 3.4.11 Factors Affecting Workpiece Roughness p. 82
- 3.5 Effect of Dressing p. 85
- 3.6 Summary of Principal Kinematic Parameters p. 87
- References p. 89
- 4 Contact Mechanics p. 91
- 4.1 Contact Area p. 91
- 4.2 Contact Length p. 93
- 4.2.1 Due To Deflection p. 93
- 4.2.2 Due To Depth of Cut p. 94
- 4.2.3 Combined Deflection and Depth of Cut p. 95
- 4.3 Smooth Body Analysis p. 99
- 4.4 Rough Surface Analysis p. 103
- 4.5 Experimental Measurements of Roughness Factor (R_r) p. 106
- 4.5.1 Comparison With Measurements by Verkerk p. 107
- 4.5.2 Effect of Depth of Cut p. 108
- 4.5.3 Effect of Workspeed p. 110
- 4.5.4 Evaluation of Roughness Factor, R_r , and Contact Length, l_c p. 111
- 4.6 Elastic Stresses Due to Abrasion p. 114
- 4.7 Summary of Contact Stress Implications p. 117
- References p. 118
- 5 Forces, Friction, and Energy p. 121
- 5.4 Examples of Materials and Their Grinding Conditions p. 125
- 5.1 Introduction p. 121
- 5.2 Forces and Power p. 122
- 5.3 Forces: Specific Energy and Efficiency p. 124

- 5.4.1 Gray Cast Iron p. 125
- 5.4.2 Medium Carbon Steel, AISI 1055 p. 126
- 5.4.3 C1023 Nickel-based Alloy p. 128
- 5.5 The Size Effect p. 130
- 5.5.1 The Sliced Bread Analogy p. 132
- 5.5.2 Cutting, Ploughing, and Rubbing p. 135
- 5.5.3 Threshold Force for Cutting p. 136
- 5.5.4 Grain Sharpness p. 136
- 5.6 Effect of Wear Flat Area on Specific Energy p. 138
- 5.6.1 Chip Formation Energy p. 138
- 5.6.2 Sliding Energy p. 139
- 5.6.3 The Ploughing Energy p. 140
- 5.7 Wear and Dressing Conditions p. 142
- 5.8 Effect of Dressing Tool Wear p. 144
- 5.9 The Nature of the Grinding Forces p. 145
- 5.10 Force Ratio and Friction Coefficient p. 148
- 5.10.1 Blunt Asperity Contact (Adhesion Friction) p. 148
- 5.10.2 Sharp Asperity Contact (Abrasive Cone Friction) p. 152
- 5.10.3 Combined Cone and Sphere Model p. 154
- 5.11 Adhesive and Abrasive Wheel Wear p. 155
- 5.12 Slip-Line Field Solutions p. 158
- 5.12.1 Wave Model of Rubbing p. 160
- 5.12.2 Wave Removal Model of Wear p. 164
- 5.12.3 Chip Removal Models of Abrasion p. 164
- 5.13 Three-Dimensional Pyramid Model of Grinding p. 167
- 6 Thermal Design of Processes p. 177
- 5.14 Limit Charts p. 170
- 5.15 Process Optimization and Wheelspeed p. 172
- References p. 175
- 6.1 Introduction p. 177
- 6.2 Examples of Surface Damage p. 178
- 6.2.1 Discoloration p. 178
- 6.2.2 Softening p. 178
- 6.2.3 Re-hardening p. 180
- 6.2.4 Cracks p. 183
- 6.2.5 Spheroidal Swarf p. 184
- 6.2.6 Tensile Residual Stresses p. 184
- 6.5 Temperatures in Grinding p. 194
- 6.2.7 Mechanically Induced Stresses p. 186
- 6.3 Thermal Modeling--Key Developments p. 187
- 6.4 Rate of Heat Generation p. 191
- 6.6 Heat Conduction in the Workpiece p. 199
- 6.7 Flux Distribution p. 201
- 6.8 Peclet Number p. 206
- 6.9 Temperatures in the Contact Area p. 208
- 6.9.1 A Uniform Heat Flux p. 208

- 6.9.2 Triangular Heat Flux p. 209
- 6.9.3 Trapezoidal Heat Flux p. 210
- 6.9.4 Maximum Temperatures p. 211
- 6.10 Heat Flows in the Contact Area and Partitioning p. 212
- 6.10.1 Heat Flow to the Chips p. 213
- 6.10.2 Heat Flow to the Process Fluid p. 214
- 6.10.3 Heat Flow to the Workpiece and the Abrasive p. 215
- 6.10.4 Heat Flow to the Workpiece p. 215
- 6.10.5 Maximum Workpiece Temperature p. 215
- 6.11 Case Studies on Process Variations and Process Design p. 217
- 6.11.1 Case Study 1: Shallow-cut Grinding-10 [μ]m Cut p. 217
- 6.11.2 Case Study 2: Creep Grinding-1 mm Cut p. 219
- 6.11.3 Case Study 3: Creep-feed Grinding-20 mm Cut p. 221
- 6.11.4 Case Study 4: High Efficiency Deep Grinding (HEDG) p. 224
- 6.12 Subsurface Temperatures p. 227
- 6.13 Work-Abrasive Partition Ratio - R_{ws} p. 230
- 6.13.1 Analysis of h_{wg} p. 231
- 6.13.2 Analysis of h_g p. 232
- Appendix p. 235
- References p. 236
- 7 Molecular Dynamics for Abrasive Process Simulation p. 239
- 7.1 Introduction p. 239
- 7.2 Concept and Basic Elements of Molecular Dynamics p. 240
- 7.2.1 Material Representation: The Potential Function p. 242
- 7.3 Requirements for Molecular Dynamics Simulations of Abrasive Processes p. 246
- 7.4 Application Examples for Molecular Dynamics Simulation of Abrasive Processes p. 248
- 7.4.4 Indenting a Brittle Semiconductor Material p. 258
- 7.4.1 Orthogonal Cutting of a Ductile, Single-crystalline Material p. 248
- 7.4.2 A Model for Investigating the Pile-up Formation in Abrasive Machining p. 254
- 7.4.3 Machining of Ductile, Polycrystalline Materials p. 256
- 7.5 Summary and Outlook p. 261
- References p. 262
- 8 Fluid Delivery p. 265
- 8.3.1 The Turbulent Orifice Nozzle p. 277
- 8.1 The Role of Process Fluids p. 265
- 8.2 Overcoming the Air Barrier in High Speed Grinding p. 268
- 8.3 Nozzles for High Speed Grinding p. 275
- 8.3.2 The Transitional and Laminar Flow Capillary Nozzle p. 279
- 8.3.3 The Slot Nozzle p. 280
- 8.3.4 The Shoe Nozzle p. 281
- 8.4 Energy and Momentum Requirements of the Process Fluid p. 282
- 8.4.1 Velocity Requirement for a Jet Nozzle p. 283
- 8.5 Useful Flowrate Through the Grinding Contact p. 284
- 8.6 Mechanics of Cooling in Creep Grinding p. 287
- 8.6.1 Estimating the Thickness of the Thermal Boundary Layer p. 290

- 8.6.2 Application of Coolant in Creep Grinding p. 292
- 8.7 Summary of Conclusions p. 295
- References p. 295
- 9 Electrolytic In-process Dressing (ELID) Grinding and Polishing p. 297
- 9.1 Introduction p. 297
- 9.2 Basic System p. 298
- 9.3 Basic Principles p. 299
- 9.4 Electrical Aspects of Elid Grinding p. 303
- 9.5 Grinding Wheels for Elid Applications p. 305
- 9.6 Elid Grinding of Ceramics p. 305
- 9.9.1 ELID Face-grinding p. 313
- 9.7 Material Removal Mechanisms In Grinding of Ceramics and Glasses p. 308
- 9.8 Comparison Between Elid and Other Grinding Techniques p. 311
- 9.9 Applications of Elid Grinding p. 312
- 9.9.2 ELID Duplex (Double-sided) Grinding p. 314
- 9.9.3 ELID Lap-grinding p. 316
- 9.9.4 ELID Grinding of Ceramics on a Vertical Rotary Surface Grinder p. 319
- 9.9.5 ELID Grinding of Ceramics on a Vertical Grinding Center p. 321
- 9.9.6 ELID Grinding of Bearing Steels p. 324
- 9.9.7 ELID Grinding of Ceramic Coatings p. 329
- 9.9.8 ELID Ultra-Precision Grinding of Aspheric Mirrors p. 331
- References p. 340
- 9.9.9 ELID Grinding of Microspherical Lens p. 331
- 9.9.10 ELID Grinding of Large Optical Glass Substrates p. 332
- 9.9.11 ELID Precision Internal Grinding p. 332
- 9.9.12 ELID Grinding of Hard Steels p. 335
- 9.9.13 ELID Mirror Grinding of Carbon Fiber Reinforced Plastics p. 337
- 9.9.14 ELID Grinding of Chemical Vapor Deposited Silicon Nitride p. 338
- 9.10 Conclusions p. 338
- 10 Grinding Wheel and Abrasive Topography p. 343
- 10.1 Basic Wheel Shape p. 343
- 10.1.1 Misalignment p. 344
- 10.1.2 Profile Errors p. 345
- 10.1.3 Vibrations p. 346
- 10.2 The Importance of Microtopography p. 347
- 10.3 Topographical Definitions p. 349
- 10.3.1 Cutting Edge Dullness (γ) p. 350
- 10.3.2 Cutting Edge Density (C_a) p. 350
- 10.3.3 Effective Porosity Ratio (V_{pw}) p. 353
- 10.4 Measurement Techniques p. 355
- 10.4.1 Stylus Techniques p. 355
- 10.4.2 Microscopy p. 357
- 10.4.3 Comparison of Measurement Ranges p. 361
- 10.4.4 Replication Techniques p. 362
- 10.4.5 Image Processing p. 363
- 10.5 Topography Changes in Grinding p. 363

- 10.6 Grinding Inconel 718 p. 365
- References p. 367
- 11 Abrasives and Abrasive Tools p. 369
- 11.1 Introduction p. 369
- 11.2 Conventional Abrasive Grain Materials p. 370
- 11.2.1 Aluminum Oxide (Al_2O_3)-based Abrasives p. 370
- 11.2.2 Garnet p. 379
- 11.2.3 Quartz p. 379
- 11.2.4 Silicon Carbide (SiC) p. 380
- 11.3.1 Natural Diamond p. 385
- 11.2.5 Polishing Abrasives p. 381
- 11.2.6 Abrasive Wheel Type-marking p. 384
- 11.3 Superabrasives p. 385
- 11.3.2 Synthetic Diamond p. 390
- 11.3.3 Chemical-Physical Properties of Diamond p. 392
- 11.3.4 Cubic Boron Nitride (CBN) p. 393
- 11.3.5 Boron Nitride (B_4N) p. 394
- 11.4 Structure of Superabrasives p. 394
- 11.4.1 Structure of Diamond p. 395
- 11.4.2 Structure of Cubic Boron Nitride (CBN) p. 395
- 11.4.3 PCD Diamond p. 397
- 11.4.4 CVD Diamond p. 398
- 11.5 Grit Sizes, Grit Shapes, and Properties p. 398
- 11.5.1 Grit Sizes p. 398
- 11.5.2 Modern Grain Developments p. 399
- 11.5.6 Specific Gravity p. 402
- 11.5.3 Friability p. 401
- 11.5.4 Hardness p. 402
- 11.5.5 Grain Shape p. 402
- 11.5.7 Porosity p. 403
- 11.5.8 Properties of Diamond p. 403
- 11.5.9 Properties of CBN p. 405
- 11.6 Bonds p. 407
- 11.6.1 Bonds for Conventional Abrasives p. 408
- 11.6.2 Bonds for Single-layer Superabrasives p. 415
- 11.6.3 Bonds for Multilayer Diamond p. 417
- 11.6.4 Bonds for Multilayer CBN p. 418
- 11.7 Design and Specification of Grinding Wheels p. 422
- 11.7.1 Conventional Grinding Wheels p. 422
- 11.7.2 Multilayer Superabrasive Grinding Wheels p. 425
- 11.7.3 Electroplated Single-layer Superabrasive Grinding Wheels p. 425
- 11.7.4 Wheel Shape and Tolerances p. 430
- 11.7.5 Wheel Balancing p. 431
- 11.7.6 Design of High-speed Wheels p. 433
- 11.7.7 Chatter Suppression p. 439
- 11.8 Abrasive Pastes p. 442

- 11.8.1 Binders for Abrasive Pastes p. 442
- 11.9 Coated Abrasives and Abrasive Belts p. 443
- 11.9.1 Coated Abrasive Tools p. 443
- 11.9.2 Backing Materials for Coated Abrasives p. 444
- 11.9.3 Adhesives for Abrasive Belts p. 445
- 11.9.4 Comparison Between Grinding Wheels and Abrasive Belts p. 445
- 11.9.5 Abrasive Belts in Furniture Production p. 445
- 11.9.6 Abrasive Grains for Abrasive Belts p. 446
- 11.9.7 Backings for Abrasive Belts p. 446
- References p. 447
- United States Patents p. 453
- American National Standards Institute p. 453
- 12.2 Grinding Wheel Preparation p. 457
- Japanese Industrial Standards p. 453
- International Standards Organization p. 453
- Grinding Wheel Manufacturers' Literature p. 454
- 12 Conditioning of Abrasive Wheels p. 457
- 12.1 Introduction p. 457
- 12.3 Grinding Wheel Conditioning p. 458
- 12.3.1 Introduction p. 458
- 12.3.2 Cleaning-up a Wheel p. 461
- 12.3.3 Truing p. 462
- 12.3.4 Dressing p. 463
- 12.4 Dressing Tools p. 464
- 12.4.1 Introduction p. 464
- 12.4.2 Ultra-hard Materials for Dressing Tools p. 464
- 12.4.3 Traverse Dressers p. 468
- 12.4.4 Roll Dressers p. 468
- 12.5 Technologies for Conditioning Vitrified Conventional Wheels p. 471
- 12.5.1 Conditioning by Traversing the Diamond Tool Across the Wheel p. 471
- 12.5.2 Diamond Roller Dressing p. 473
- 12.5.3 Crush Dressing p. 474
- 12.5.4 Continuous Dressing (CD) Using a Diamond Roller p. 475
- 12.6.3 Dressing Superabrasive Wheels p. 478
- 12.6 Technologies for Conditioning Superabrasive Wheels p. 476
- 12.6.1 Introduction p. 476
- 12.6.2 Truing Superabrasive Wheels p. 476
- 12.7 Nonconventional Technologies for Wheel Conditioning p. 479
- 12.8 Removal Mechanisms in Conventional Conditioning p. 480
- 12.8.1 Introduction p. 480
- 12.8.2 Mechanism of Dressing Conventional Vitrified Wheels p. 482
- 12.8.3 Mechanism of Conditioning Superabrasive Wheels p. 483
- 12.9 Microtopography of Conditioned Wheel p. 486
- 12.9.1 Introduction p. 486
- 12.9.2 Experimental Methods for Representation of Wheel Microtopography p. 487
- 12.10 Wear of the Dressing Tools p. 488

- 12.10.1 Introduction p. 488
- 12.10.2 Influence of the Wheel Specification p. 489
- 12.10.3 Influence of the Ultra-hard Components of the Dresser p. 489
- 12.11 Conclusions p. 494
- References p. 495
- 13 Loose Abrasive Processes p. 499
- 13.1 Introduction p. 499
- 13.2 Two-Body and Three-Body Abrasion (Mechanisms) p. 504
- 13.3 The Lapping Process p. 507
- 13.3.1 The Lap p. 508
- 13.3.2 The Abrasive p. 509
- 13.3.3 The Lapping Fluid p. 513
- 13.3.4 Lapping Types p. 515
- 13.4 Polishing Process p. 518
- 13.5 Chemo-Mechanical Polishing (CMP) p. 524
- References p. 528
- 14 Process Fluids for Abrasive Machining p. 531
- 14.1.3 Three Main Groups of Fluids p. 533
- 14.1 Process Fluids as Lubricants p. 531
- 14.1.1 Alternative Lubrication Techniques p. 531
- 14.1.2 Benefits of Lubricants in Abrasive Machining p. 533
- 14.1.4 Demands Arising from New Materials and Applications p. 534
- 14.2 Lubrication Regimes p. 534
- 14.2.1 The Stribeck Curve p. 534
- 14.2.5 Lubrication in Abrasive Machining Contacts p. 538
- 14.2.2 Hydrodynamic Lubrication p. 535
- 14.2.3 Boundary/Mixed Lubrication p. 536
- 14.2.4 Elastohydrodynamic Lubrication (EHL) p. 537
- 14.3 Viscosity p. 538
- 14.3.1 Dynamic Viscosity, $[\eta]$ p. 538
- 14.3.2 Kinematic Viscosity, ν p. 539
- 14.3.3 Dependence of Viscosity on Temperature p. 539
- 14.3.4 Viscosity Index for Temperature p. 539
- 14.3.5 Viscosity Index for Pressure p. 540
- 14.4 Friction Coefficient in Mixed/Boundary Lubrication p. 540
- 14.5 Classification of Process Fluids p. 542
- 14.6 Neat Oils p. 542
- 14.6.1 Natural Fatty Oils p. 542
- 14.6.2 Mineral Oils p. 543
- 14.6.3 Synthetic Neat Oils p. 545
- 14.6.4 Classification of Neat Oils by Additives p. 546
- 14.7 Water-Based Fluids p. 546
- 14.7.1 Physical Aspects p. 546
- 14.7.2 Properties of Water as a Base Liquid p. 549
- 14.8 Water Solutions p. 550
- 14.8.1 Mineral Salt Solutions p. 551

- 14.8.2 Water Solutions of Synthetic Organic Compounds p. 551
- 14.9 Water-Oil Emulsions p. 551
- 14.9.1 Oil-concentrate Emulsions p. 552
- 14.9.2 Semisynthetic Emulsions p. 552
- 14.9.3 Synthetic Emulsions p. 552
- 14.10 The Influence of Additives p. 553
- 14.11 Physical Properties of Process Fluids p. 555
- 14.11.1 Density p. 555
- 14.11.2 Viscosity and Viscosity Index p. 555
- 14.11.3 Color p. 555
- 14.11.4 Transparency p. 556
- 14.11.5 Fluorescence p. 556
- 14.11.6 Detergency p. 556
- 14.11.7 Dispersive Ability p. 556
- 14.11.8 Foam Depressing p. 556
- 14.11.9 Flash Point p. 557
- 14.11.10 Emulsion Stability p. 557
- 14.11.11 Cooling Properties p. 558
- 14.11.12 Boiling Point p. 558
- 14.12 Chemical Properties of Process Fluids p. 558
- 14.12.1 Thermal Stability (TS) p. 558
- 14.12.2 Oxidation Stability p. 559
- 14.12.3 Catalytic Effects of Metals p. 559
- 14.12.4 Fluid Corrosivity p. 559
- 14.12.5 Rusting p. 560
- 14.12.6 Ash Content p. 560
- 14.13 Tribological Properties of Process Fluids p. 560
- 14.13.1 Friction Properties p. 561
- 14.13.2 Wear Resistance p. 561
- 14.13.3 Extreme Pressure (EP) Properties p. 561
- 14.15 Degradation of Fluid Properties During Operation p. 563
- 14.16 Analysis of Physico-Chemical and Biological Properties p. 564
- 14.16.1 Water-based Emulsion and/or Solution Characteristics p. 564
- 14.16.2 Corrosion Inhibition p. 567
- 14.16.3 Heat Transfer Rate p. 567
- 14.16.4 Thermal Reactivity of the Tribosystem p. 567
- 14.16.5 Biological Characteristics p. 569
- 14.17 Tribological and Application Characteristics p. 569
- 14.18 Adjustment of Fluid Properties in Operation p. 572
- 14.19 Selection of Process Fluids p. 573
- 14.20 Conclusions and Recommendations p. 579
- References p. 580
- 15 Tribochemistry of Abrasive Machining p. 587
- 15.1 Definition of Tribochemistry p. 587
- 15.2 Modeling a Tribochemical Process p. 591
- 15.2.1 Special Factors in Abrasive Machining p. 591

- 15.2.2 The Magma-Plasma Model for Abrasive Machining p. 592
- 15.3 Tribochemical Behavior of Abrasive Tools p. 595
- 15.3.1 General Aspects p. 595
- 15.3.2 Triboreactions Between Tool and Workpiece p. 595
- 15.4.1 Initial Structure of a Rough-machined Workpiece p. 604
- 14.14 Biological Properties of Process Fluids p. 562
- 15.3.3 Triboreactions Between Tool and Environment p. 601
- 15.4 Tribochemical Aspects of the Workmaterial Structure p. 603
- 15.4.5 Workmaterial Selection by Tribosimulation p. 608
- 15.4.2 The Rehbinder Effect and Tribological Implications p. 605
- 15.4.3 Other Tribochemical Interactions Between Workmaterial and Surround p. 606
- 15.4.4 Influence of the Chemical Composition of Workmaterial p. 607
- 15.5 Tribochemical Aspects of Dry Abrasive Machining p. 610
- 15.6 Tribochemical Aspects of Wet Abrasive Machining p. 611
- 15.6.1 Lubrication by a Tribosorption Layer p. 611
- 15.6.2 Lubrication by Chemical Triboreaction Layers p. 614
- 15.6.3 Lubrication in Extreme Pressure (EP) Conditions p. 616
- 15.6.4 Combined Effects of Tribochemical Processes Induced by Additivation p. 622
- 15.7 Conclusions p. 625
- References p. 626
- 16 Processed Materials p. 635
- 16.1 Importance of Material Properties p. 635
- 16.2 Structural Aspects of Metals p. 638
- 16.2.1 Control and Modification of Structure in Metals p. 640
- 16.2.2 Machinability of Metals p. 643
- 16.3 Structural Aspects of Nonmetals p. 645
- 16.3.1 Advanced Ceramics p. 645
- 16.3.2 Optical Glasses p. 646
- 16.3.3 Crystallized Minerals p. 646
- 16.4 Structural Aspects of Transitional Materials p. 647
- 16.4.1 Composite Materials p. 647
- 16.4.2 Polymers p. 649
- 16.5 Adverse Tribochemical Effects in Abrasive Machining p. 650
- 16.5.1 Physico-Chemical Effects p. 650
- 16.5.2 Prevention of Adverse Tribochemical Effects p. 651
- 16.6.3 Tribology of Abrasives in Abrasive Machining p. 656
- 16.6 Tribological Aspects of Abrasive Machining p. 652
- 16.6.1 General Aspects p. 652
- 16.6.2 Tribology of Metals in Abrasive Machining p. 653
- 16.6.4 Tribology of Ceramic and Glass Processing p. 657
- 16.6.5 Abrasive Machining Tribology of Polymeric Materials p. 659
- 16.7 Concluding Comments p. 659
- References p. 661
- Symbols and Units p. 665
- Symbols p. 665
- Si Units p. 671

- Consistency of Units in Equations p. 672
- Si--British Conversion Factors p. 672
- Glossary p. 675
- Index p. 699